

TAI-SAW TECHNOLOGY CO., LTD. No. 3, Industrial 2nd Rd., Ping-Chen Industrial District,

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# **Product Specifications Approval Sheet**

Product Description: Crystal Unit SMD 3.2x2.5 25.00MHz

TST Part No.: TZ0748D

Customer Part No.:\_\_\_\_\_

Customer signature	required	
Company:		
Division:		
Approved by :		
Date:		
Checked by:	Chia Haur Rau	CH
Approved by:	Kelly Huang	Kuly Huang
Date:	06/09/2017	

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.

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3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



MODEL NO.: TZ0748D

REV. NO.: 2

### **Revise:**

Rev.	Rev.	Rev. Account	Date	Ref. No.	Revised by
1	Page N/A	Initial release	04/23/12'	N/A	Jeraul Chao
2	3, 6	Change ESR max to $35\Omega$ ,	06/09/17'	ECN-201700234	Chia Haur Rau
		Nominal Drive Level to 200uW			
		max and add MSL spec.			

TST DCC Release document



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Crystal Unit SMD 3.2x2.5 25.00MHz

#### MODEL NO.: TZ0748D

#### REV. NO.: 2

## Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package

## **Description and Applications:**

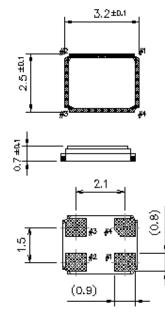
Surface mount 3.2mmx2.5mm crystal unit for customer for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

## **Electrical Specifications:**

TZ0748D	Specification
Nominal Frequency	25.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +85°C
Operating Temperature Range	-40°C to +85°C
Frequency Stability over Operating Temperature Range	+/-20 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-20 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	35 $\Omega$ max
Nominal Drive Level	10uW typical and 200uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	12.0 pF
Insulation Resistance	500 MΩ min./DC 100V
Aging	+/-1ppm
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g

RoHS Compliant Lead free Lead-free soldering

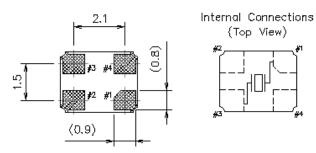
# Mechanical Dimensions (mm): Base 1



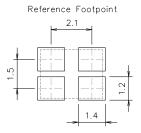
	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN /OUT
#4 pín	GND

Internal Connections (Top View)

Base 2

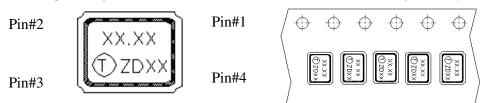


## Recommended Land Pattern: (unit: mm)



## Marking:

Line 1: Frequency (25.00) Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code (1 or 2 letters)



#### The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

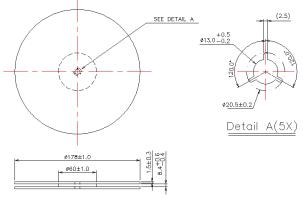
#### **Product Code Table**

	2013	2014	2015	2016
Year	2017	2018	2019	2020
	2021	2022	2023	2024
product code	Z	Z	<u>Z</u>	Ξ

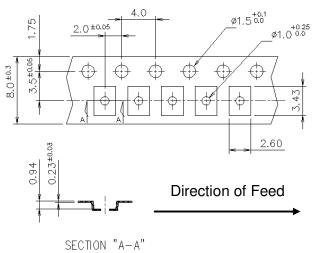
#### **Date Code Table**

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	E	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	s	t	u	v	w	х	у	z

#### **Reel Dimensions (mm):**



#### Tape Dimensions (mm):



#### [NOTE]

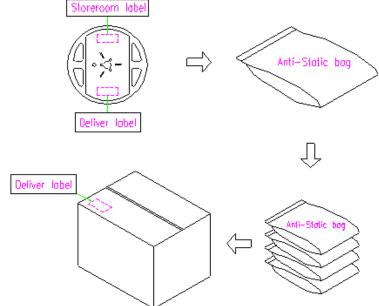
- 1 UNIT : mm.
- 2 UNLESS OTHERWISE SPECIFIED TOLERANCEON DIM. +/-0.1mm.
- 3 MATERIAL : CONDUCTIVE POLYSTYRENE.
- 4 COLOR : BLACK.
- 5 10 PITCHES CUMULATIVETOLERANCE +/-0.2mm.

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# Packing Quantity/Packing:

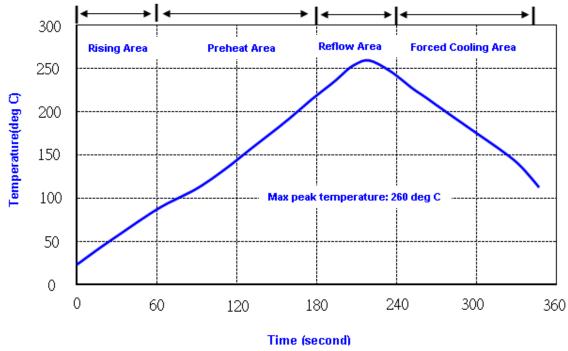
3K pcs maximum per reel



## MSL : Level-1

## Place of Production : Taiwan

## **Reflow Profile: Two times in process before function test**



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec 2. Temperature: 217+/-5 deg C; Time: 90~100 sec TAI-SAW TECHNOLOGY CO., LTD. TST DCC Release document

# **Reliability Specifications**

Test name Test process / method		Reference standard						
Mechanical characteristics								
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C / 10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)						
Vibration	Total peak amplitude : 1.5mmVibration frequency: 10 to 2000 HzSweep period: 20 minuteVibration directions: 3 mutually perpendicularDuration: 2 hr / direc.	MIL-STD 202G method 204						
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213						
Solderability	Solder Temperature:265±5℃ Duration time: 5±0.5 seconds.	J-STD-002						
Environmental	characteristics							
Thermal Shock	Heat cycle conditions -40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8						
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103						
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A						
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 ℃ Duration : 96 hours	IEC 60068-2-1						